TEMD7000X01

Vishay Semiconductors



Silicon PIN Photodiode

FEATURES

- Package type: surface mount
- Package form: 0805
- Dimensions (L x W x H in mm): 2 x 1.25 x 0.85
- Radiant sensitive area (in mm²): 0.23
- High photo sensitivity
- · High radiant sensitivity
- · Suitable for visible and near infrared radiation
- Fast response times
- Angle of half sensitivity: $\varphi = \pm 60^{\circ}$
- Floor life: 168 h, MSL 3, according to J-STD-020
- · Lead (Pb)-free reflow soldering
- AEC-Q101 qualified
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

High speed photo detector

PRODUCT SUMMARY							
COMPONENT	I _{ra} (μΑ)	φ (deg)	λ _{0.1} (nm)				
TEMD7000X01	3	± 60	350 to 1120				

Note

DESCRIPTION

visible and near infrared radiation.

• Test conditions see table "Basic Characteristics"

ORDERING INFORMATION ORDERING CODE PACKAGING REMARKS PACKAGE FORM TEMD7000X01 Tape and reel MOQ: 3000 pcs, 3000 pcs/reel 0805

Note

MOQ: minimum order quantity

ABSOLUTE MAXIMUM RATINGS (T _{amb} = 25 °C, unless otherwise specified)							
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT			
Reverse voltage		V _R	60	V			
Power dissipation	T _{amb} ≤ 25 °C	Pv	215	mW			
Junction temperature		Tj	100	°C			
Operating temperature range		T _{amb}	-40 to +100	°C			
Storage temperature range		T _{stg}	-40 to +100	°C			
Soldering temperature	Acc. reflow solder profile fig. 8	T _{sd}	260	°C			
Thermal resistance junction / ambient	Acc. J-STD-051	R _{thJA}	270	K/W			



TEMD7000X01 is a high speed and high sensitive PIN photodiode. It is a miniature surface mount device (SMD)

including the chip with a 0.23 mm² sensitive area detecting



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TEMD7000X01



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BASIC CHARACTERISTICS (T _{amb} = 25 °C, unless otherwise specified)							
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT	
Forward voltage	I _F = 50 mA	V _F		1		V	
Breakdown voltage	I _R = 100 μA, E = 0	V _(BR)	60			V	
Reverse dark current	V _R = 10 V, E = 0	I _{ro}		1	3	nA	
Diode capacitance	$V_{R} = 0 V, f = 1 MHz, E = 0$	CD		4		pF	
	V _R = 5 V, f = 1 MHz, E = 0	CD		1.3		pF	
Open circuit voltage	$E_e = 1 \text{ mW/cm}^2$, $\lambda = 950 \text{ nm}$	Vo		350		mV	
Temperature coefficient of Vo	$E_e = 1 \text{ mW/cm}^2$, $\lambda = 950 \text{ nm}$	TK _{Vo}		-2.6		mV/K	
Short circuit current	$E_e = 1 \text{ mW/cm}^2$, $\lambda = 950 \text{ nm}$	l _k		3		μA	
Temperature coefficient of I_k	$E_e = 1 \text{ mW/cm}^2$, $\lambda = 950 \text{ nm}$	TK _{lk}		0.1		%/K	
Reverse light current	$E_e = 1 \text{ mW/cm}^2$, $\lambda = 950 \text{ nm}$, $V_R = 5 \text{ V}$	I _{ra}	2.4	3	3.6	μA	
Angle of half sensitivity		φ		± 60		deg	
Wavelength of peak sensitivity		λρ		900		nm	
Range of spectral bandwidth		λ _{0.1}		350 to 1120		nm	
Rise time	V_R = 10 V, R_L = 1 k Ω , λ = 820 nm	t _r		100		ns	
Fall time	V_R = 10 V, R_L = 1 k Ω , λ = 820 nm	t _f		100		ns	

BASIC CHARACTERISTICS (Tamb = 25 °C, unless otherwise specified)

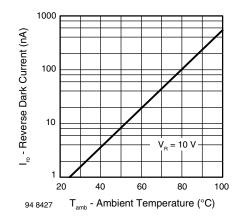


Fig. 1 - Reverse Dark Current vs. Ambient Temperature

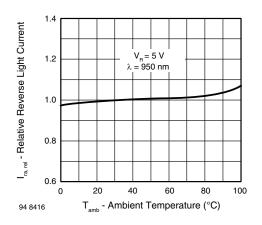


Fig. 2 - Relative Reverse Light Current vs. Ambient Temperature

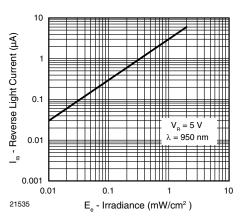


Fig. 3 - Reverse Light Current vs. Irradiance

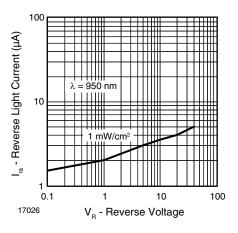


Fig. 4 - Reverse Light Current vs. Reverse Voltage

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TEMD7000X01



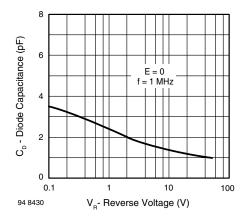


Fig. 5 - Diode Capacitance vs. Reverse Voltage

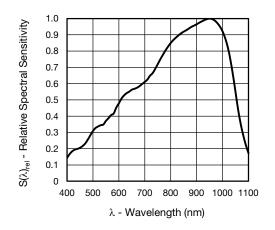


Fig. 6 - Relative Spectral Sensitivity vs. Wavelength

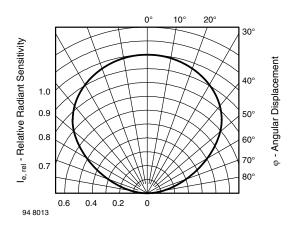


Fig. 7 - Relative Radiant Sensitivity vs. Angular Displacement

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REFLOW SOLDER PROFILE

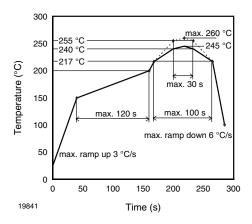


Fig. 8 - Lead (Pb)-free Reflow Solder Profile acc. J-STD-020

DRYPACK

Devices are packed in moisture barrier bags (MBB) to prevent the products from moisture absorption during transportation and storage. Each bag contains a desiccant.

FLOOR LIFE

Floor life (time between soldering and removing from MBB) must not exceed the time indicated on MBB label:

Floor life: 168 h

Conditions: T_{amb} < 30 °C, RH < 60 %

Moisture sensitivity level 3, according to J-STD-020.

DRYING

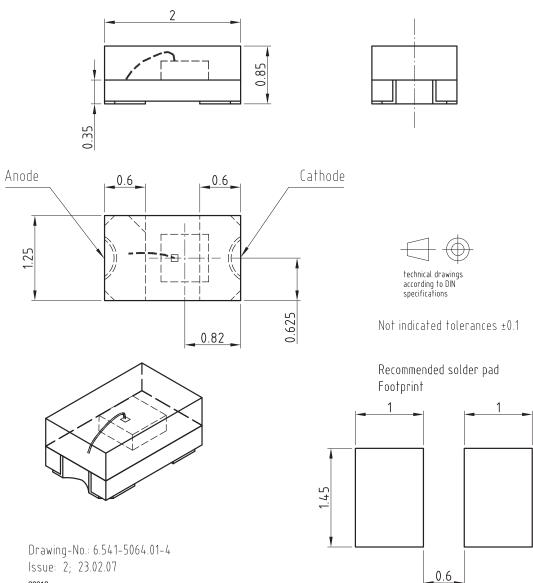
In case of moisture absorption devices should be baked before soldering. Conditions see J-STD-020 or label. Devices taped on reel dry using recommended conditions 192 h at 40 °C (+ 5 °C), RH < 5 %.



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PACKAGE DIMENSIONS in millimeters

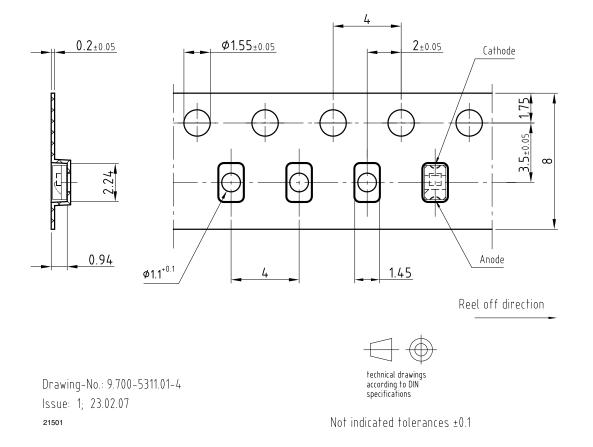


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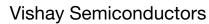


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BLISTER TAPE DIMENSIONS in millimeters

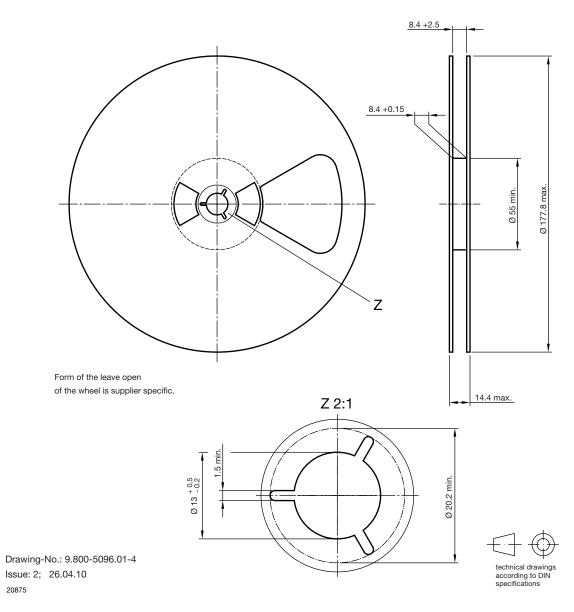








REEL DIMENSIONS in millimeters



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